AMENDMENTS TO THE CLAIMS

The following listing of claims replaces all prior versions, and listings, of claims in the application:

Claims 1-23 (Canceled)

- 24. (Previously presented) A nitride based heterostructure device comprising:
 - a substrate;
 - a buffer layer directly on the substrate, wherein the buffer layer includes In:
 - a first layer including GaN directly on the buffer layer;
 - a second layer directly on the first layer, wherein the second layer includes AlGaN; and
 - a quaternary layer directly on the second layer, wherein the quaternary layer includes

AlInGaN.

- 25. (Previously presented) The device of claim 24, wherein the substrate includes one of the group comprising sapphire, SiC, ZnO, a spinel substrate, Si, anodized alumina, and AIN.
- 26. (Previously presented) The device of claim 24, wherein the quaternary layer includes about a 20% to about 30% molar fraction of Al.
- 27. (Previously presented) The device of claim 26, wherein the quaternary layer further includes about a 2% to about 5% molar fraction of In.

- 28. (Previously presented) The device of claim 24, wherein the first layer further includes In.
- 29. (Previously presented) A nitride based heterostructure device comprising:
 - a substrate;
 - a buffer layer directly on the substrate, wherein the buffer layer includes In;
 - a ternary layer directly on the buffer layer, wherein the ternary layer includes Ga, In, and

N; and

- a quaternary layer directly on the ternary layer, wherein the quaternary layer includes Ga, Al, In, and N.
- 30. (Previously presented) The device of claim 29, wherein the buffer layer includes Al and N.

Claims 31-34 (Canceled)

- 35. (Previously presented) A nitride based heterostructure device comprising:
 - a substrate:
 - a buffer layer on the substrate, wherein the buffer layer includes In;
 - a first layer including GaN on the buffer layer;
 - a second layer on the first layer, wherein the second layer includes AlGaN; and
- a quaternary layer on the second layer, wherein the quaternary layer includes AlInGaN,

wherein the quaternary layer includes about a 20% to about 30% molar fraction of Al.

| about a 2% to about 5% molar fraction of In. | |
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36. (Previously presented) The device of claim 35, wherein the quaternary layer further includes